

## TLV185x-Q1 和 TLV186x-Q1 系列 40V 毫微功耗比较器

### 1 特性

- 符合汽车应用要求
- 具有符合 AEC-Q100 标准的下列特性：
  - 器件温度等级 1：-40°C 至 125°C 的环境工作温度范围
  - 器件 HBM ESD 分级等级 H1C
  - 器件 CDM ESD 分类等级 C6
- 低电源电流：每通道 440nA
- 宽电源电压范围：1.8V 至 40V
- 过轨输入：共模范围比 (V-) 高 40V，与 (V+) 无关
- 失效防护：无电源时为高阻抗输入
- 上电复位可提供已知的启动条件
- 过驱动输入无相位反转
- 高达 40V 的反向电池保护
- 推挽输出选项 (TLV185x-Q1)
- 开漏输出选项 (TLV186x-Q1)

### 2 应用

- 远程信息处理 eCall
- 汽车音响主机
- 仪表组
- 车载充电器 (OBC) 和无线充电器

### 3 说明

TLV185x-Q1 和 TLV186x-Q1 是汽车级 40V 毫微功耗比较器系列，具有单通道、双通道和四通道选项。该系列提供具有推挽和开漏输出选项的失效防护 (FS) 输

入。这些特性与在 1.8V 至 40V 宽电源电压范围内的毫微功耗运行相结合，使此系列非常适合在低功耗、常开系统中的电压和温度监测等辅助控制功能。

所有器件均具有上电复位 (POR) 特性，这可确保输出处于已知状态，直到达到最小电源电压，然后输出才对输入做出响应，从而防止系统上电和断电期间出现错误输出。

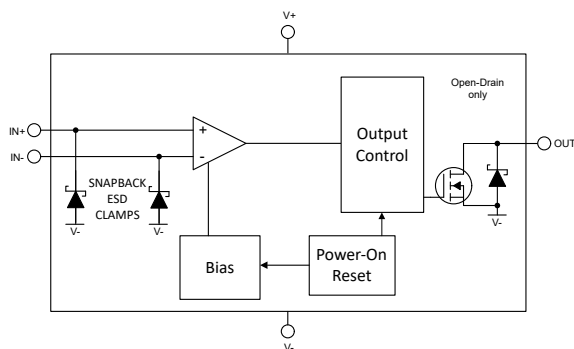
输入具有过轨功能，其中两个输入均可超过电源电压高达 40V，并且仍能正常运行。这使得比较器非常适合高电源电压和低电源电压系统，而不会限制可比较的输入电压范围。同样，内部反向电池保护功能可防止电源引脚上的电池安装不当时损坏比较器。

TLV185x-Q1 比较器具有推挽输出级，而 TLV186x-Q1 比较器具有开漏输出级，因此适用于电平转换。

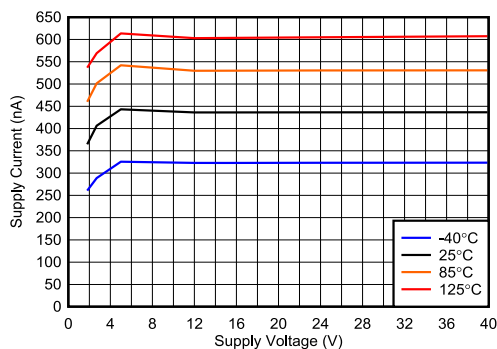
#### 器件信息

| 器件型号                      | 封装 <sup>(1)</sup> | 封装尺寸 (标称值)      |
|---------------------------|-------------------|-----------------|
| TLV1851-Q1、<br>TLV1861-Q1 | SOT-23 (5)        | 1.60mm x 2.90mm |
| TLV1852-Q1、<br>TLV1862-Q1 | SOIC (8) (预发布)    | 3.91mm x 4.90mm |
|                           | VSSOP (8) (预发布)   | 3.00mm x 3.00mm |
| TLV1854-Q1、<br>TLV1864-Q1 | SOIC (14) (预发布)   | 3.91mm x 8.65mm |
|                           | TSSOP (14) (预发布)  | 4.40mm x 5.00mm |

(1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。



方框图



电源电流与电源电压间的关系



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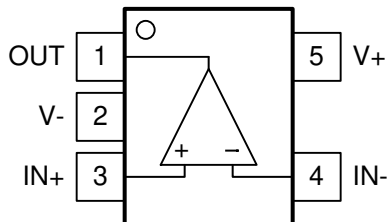
## 4 Revision History

注：以前版本的页码可能与当前版本的页码不同

| DATE        | REVISION | NOTES           |
|-------------|----------|-----------------|
| August 2023 | *        | Initial Release |

## 5 Pin Configuration and Functions

### Pin Configuration: TLV1851-Q1 and TLV1861-Q1



**DBV Package**  
**SOT-23-5**  
**Top View**  
**(Standard "north west" pinout)**

**表 5-1. Pin Functions: TLV1851-Q1 and TLV1861-Q1**

| PIN  |     | I/O | DESCRIPTION             |
|------|-----|-----|-------------------------|
| NAME | NO. |     |                         |
| OUT  | 1   | O   | Output                  |
| V-   | 2   | -   | Negative supply voltage |
| IN+  | 3   | I   | Non-inverting (+) input |
| IN-  | 4   | I   | Inverting (-) input     |
| V+   | 5   | -   | Positive supply voltage |

## Pin Configurations: TLV1852-Q1 and TLV1862-Q1

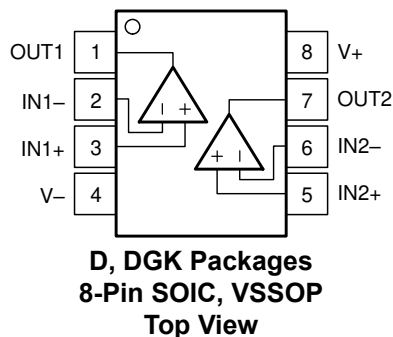
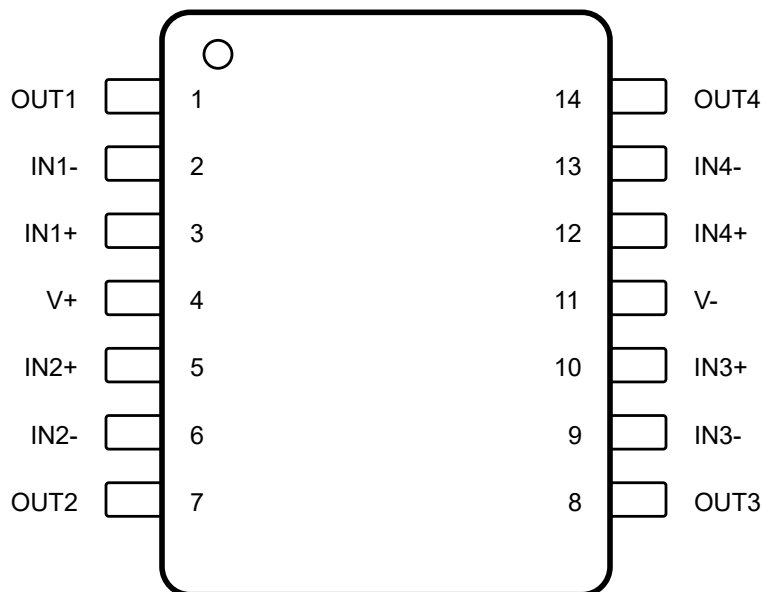


表 5-2. Pin Functions: TLV1852-Q1 and TLV1862-Q1

| PIN  |     | I/O | DESCRIPTION                            |
|------|-----|-----|----------------------------------------|
| NAME | NO. |     |                                        |
| OUT1 | 1   | O   | Output pin of the comparator 1         |
| IN1– | 2   | I   | Inverting input pin of comparator 1    |
| IN1+ | 3   | I   | Noninverting input pin of comparator 1 |
| V–   | 4   | —   | Negative supply voltage                |
| IN2+ | 5   | I   | Noninverting input pin of comparator 2 |
| IN2– | 6   | I   | Inverting input pin of comparator 2    |
| OUT2 | 7   | O   | Output pin of the comparator 2         |
| V+   | 8   | —   | Positive supply voltage                |

## Pin Configurations: TLV1854-Q1 and TLV1864-Q1



Not to scale

**D, PW Packages**  
**14-Pin SOIC, TSSOP**  
**Top View**

**表 5-3. Pin Functions: TLV1854-Q1 and TLV1864-Q1**

| PIN  |     | I/O | DESCRIPTION                            |
|------|-----|-----|----------------------------------------|
| NAME | NO. |     |                                        |
| OUT1 | 1   | O   | Output pin of the comparator 1         |
| IN1- | 2   | I   | Negative input pin of the comparator 1 |
| IN1+ | 3   | I   | Positive input pin of the comparator 1 |
| V+   | 4   | -   | Positive supply voltage                |
| IN2+ | 5   | I   | Positive input pin of the comparator 2 |
| IN2- | 6   | I   | Negative input pin of the comparator 2 |
| OUT2 | 7   | O   | Output pin of the comparator 2         |
| OUT3 | 8   | O   | Output pin of the comparator 3         |
| IN3- | 9   | I   | Negative input pin of the comparator 3 |
| IN3+ | 10  | I   | Positive input pin of the comparator 3 |
| V-   | 11  | -   | Negative supply voltage                |
| IN4+ | 12  | I   | Positive input pin of the comparator 4 |
| IN4- | 13  | I   | Negative input pin of the comparator 4 |
| OUT4 | 14  | O   | Output pin of the comparator 4         |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                           | MIN  | MAX        | UNIT |
|-----------------------------------------------------------|------|------------|------|
| Supply voltage: $V_S = (V+) - (V-)$                       |      | 42         | V    |
| Differential Input Voltage, $V_{ID}$                      | -42  | 42         | V    |
| Input pins (IN+, IN-) from (V-) <sup>(2)</sup>            | -0.3 | 42         | V    |
| Current into Input pins (IN+, IN-) <sup>(3)</sup>         | -10  | 10         | mA   |
| Output (Open-drain version only) from (V-) <sup>(4)</sup> | -0.3 | 42         | V    |
| Output (OUT) (Push-Pull) from (V-)                        | -0.3 | (V+) + 0.3 | V    |
| Output short circuit current <sup>(5)</sup>               | -10  | 10         | mA   |
| Junction temperature, $T_J$                               |      | 150        | °C   |
| Storage temperature, $T_{stg}$                            | -65  | 150        | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Input terminals are diode-clamped to (V-). Inputs (IN+, IN-) can be greater than (V+) and OUT as long as it is within the -0.3 V to 42 V range
- (3) Input terminals are diode-clamped to (V-). Input signals that swing more than 0.3 V below (V-) must be current-limited to 10 mA or less.
- (4) Output (OUT) for open drain can be greater than (V+) and inputs (IN+, IN-) as long as it is within the -0.3 V to 42 V range
- (5) Short-circuit to (V-) or (V+).

### 6.2 ESD Ratings

|             |                         |                                                           | VALUE | UNIT |
|-------------|-------------------------|-----------------------------------------------------------|-------|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human-body model (HBM), , per AEC Q100-002 <sup>(1)</sup> | ±2000 | V    |
| $V_{(ESD)}$ | Electrostatic discharge | Charged-device model (CDM), per AEC Q100-0111             | ±1000 | V    |

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 6.3 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TLV185x/6x          |             |                |               |             | UNIT |
|-------------------------------|----------------------------------------------|---------------------|-------------|----------------|---------------|-------------|------|
|                               |                                              | DBV<br>(SOT-23<br>) | D<br>(SOIC) | DGK<br>(VSSOP) | PW<br>(TSSOP) | D<br>(SOIC) |      |
|                               |                                              | 5 Pins              | 8 Pins      | 8 Pins         | 14 Pins       | 14 Pins     |      |
| $R_{qJA}$                     | Junction-to-ambient thermal resistance       | 168.1               | 121.6       | 163.1          |               |             | °C/W |
| $R_{qJC(top)}$                | Junction-to-case (top) thermal resistance    | 68.1                | 64.6        | 55.5           |               |             | °C/W |
| $R_{qJB}$                     | Junction-to-board thermal resistance         | 37.4                | 65.1        | 84.7           |               |             | °C/W |
| $\gamma_{JT}$                 | Junction-to-top characterization parameter   | 11.4                | 18.1        | 5.7            |               |             | °C/W |
| $\gamma_{JB}$                 | Junction-to-board characterization parameter | 37.1                | 64.3        | 83.1           |               |             | °C/W |
| $R_{qJC(bot)}$                | Junction-to-case (bottom) thermal resistance |                     |             |                |               |             | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.4 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                                           | MIN  | MAX | UNIT |
|-------------------------------------------|------|-----|------|
| Supply voltage: $V_S = (V+) - (V-)$       | 1.8  | 40  | V    |
| Input voltage range from (V–)             | –0.1 | 40  | V    |
| Common-mode input voltage range from (V–) | 0    | 40  | V    |
| Output voltage for open drain from (V–)   | –0.1 | 40  | V    |
| Ambient temperature, $T_A$                | –40  | 125 | °C   |

## 6.5 Electrical Characteristics

For  $V_S = (V+) - (V-) = 12V$ ,  $V_{CM} = V_S/2$  at  $T_A = 25^\circ C$  (Unless otherwise noted)

| PARAMETER             |                                                | TEST CONDITIONS                                                                                                            | MIN  | TYP   | MAX  | UNIT  |
|-----------------------|------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------|------|-------|------|-------|
| OFFSET VOLTAGE        |                                                |                                                                                                                            |      |       |      |       |
| V <sub>OS</sub>       | Input offset voltage                           |                                                                                                                            | −3.6 | ±0.25 | 3.6  | mV    |
| V <sub>OS</sub>       | Input offset voltage                           | T <sub>A</sub> = −40°C to +125°C                                                                                           | −4.4 |       | 4.4  | mV    |
| dV <sub>IO</sub> /dT  | Input offset voltage drift                     |                                                                                                                            |      | 3     |      | μV/°C |
| V <sub>HYS</sub>      | Input hysteresis voltage                       |                                                                                                                            | 1    | 2.8   | 5    | mV    |
| V <sub>CM-Range</sub> | Common-mode voltage range from (V−)            | V <sub>S</sub> = 1.8 V to 40 V<br>T <sub>A</sub> = −40°C to +125°C                                                         | 0    |       | 40   | V     |
| POWER SUPPLY          |                                                |                                                                                                                            |      |       |      |       |
| I <sub>Q</sub>        | Quiescent current per comparator (output high) | Push Pull Output Option                                                                                                    |      | 520   | 750  | nA    |
| I <sub>Q</sub>        | Quiescent current per comparator (output high) | Push Pull Output Option, T <sub>A</sub> = −40 °C to 125°C                                                                  |      |       | 1000 | nA    |
| I <sub>Q</sub>        | Quiescent current per comparator (output high) | Open Drain Output option, no pull-up resistor                                                                              |      | 440   | 640  | nA    |
| I <sub>Q</sub>        | Quiescent current per comparator (output high) | Open Drain Output option, no pull-up resistor, T <sub>A</sub> = −40 °C to 125°C                                            |      |       | 850  | nA    |
| V <sub>POR</sub>      |                                                | During power on, V <sub>S</sub> must exceed V <sub>POR</sub> for t <sub>ON</sub> before the output will reflect the input. |      | 1.5   |      | V     |
| INPUT BIAS CURRENT    |                                                |                                                                                                                            |      |       |      |       |
| I <sub>B</sub>        | Input bias current <sup>(1)</sup>              |                                                                                                                            |      | 1     | 250  | pA    |
|                       |                                                | T <sub>A</sub> = −40°C to +125°C                                                                                           |      |       | 1500 | pA    |
| I <sub>OS</sub>       | Input offset current <sup>(1)</sup>            |                                                                                                                            |      | 0.1   | 100  | pA    |
|                       |                                                | T <sub>A</sub> = −40°C to +125°C                                                                                           |      |       | 1000 | pA    |
| OUTPUT                |                                                |                                                                                                                            |      |       |      |       |
| V <sub>OL</sub>       | Voltage swing from (V−)                        | I <sub>SINK</sub> = 2 μA                                                                                                   |      | 1     |      | mV    |
| V <sub>OL</sub>       | Voltage swing from (V−)                        | I <sub>SINK</sub> = 50 μA                                                                                                  |      | 20    | 60   | mV    |
|                       |                                                | I <sub>SINK</sub> = 50 μA<br>T <sub>A</sub> = −40°C to +125°C                                                              |      |       | 100  | mV    |
| V <sub>OH</sub>       | Voltage swing from (V+) (Push Pull only)       | I <sub>SOURCE</sub> = 2 μA                                                                                                 |      | 1     |      | mV    |
| V <sub>OH</sub>       | Voltage swing from (V+) (Push Pull only)       | I <sub>SOURCE</sub> = 50 μA                                                                                                |      | 25    | 60   | mV    |
|                       |                                                | I <sub>SOURCE</sub> = 50 μA<br>T <sub>A</sub> = −40°C to +125°C                                                            |      |       | 100  | mV    |
| I <sub>LKG</sub>      | Open-drain output leakage current              | V <sub>ID</sub> = +0.1 V, V <sub>PULLUP</sub> = (V+)                                                                       |      | 0.3   |      | pA    |
| I <sub>OL</sub>       | Short-circuit current                          | Sinking<br>T <sub>A</sub> = −40°C to +125°C                                                                                |      | 7     |      | mA    |

## 6.5 Electrical Characteristics (continued)

For  $V_S = (V_+) - (V_-) = 12V$ ,  $V_{CM} = V_S/2$  at  $T_A = 25^\circ C$  (Unless otherwise noted)

| PARAMETER |                       | TEST CONDITIONS                                                        | MIN | TYP | MAX | UNIT |
|-----------|-----------------------|------------------------------------------------------------------------|-----|-----|-----|------|
| $I_{OH}$  | Short-circuit current | Sourcing (for Push-Pull only)<br>$T_A = -40^\circ C$ to $+125^\circ C$ |     | 5   |     | mA   |

(1) This parameter is ensured by design and/or characterization and is not tested in production.

## 6.6 Switching Characteristics

For  $V_S = (V_+) - (V_-) = 12V$ ,  $V_{CM} = V_S/2$  at  $T_A = 25^\circ C$  (Unless otherwise noted)

| PARAMETER            |                                                         | TEST CONDITIONS                                                                                         | MIN | TYP | MAX | UNIT    |
|----------------------|---------------------------------------------------------|---------------------------------------------------------------------------------------------------------|-----|-----|-----|---------|
| <b>OUTPUT</b>        |                                                         |                                                                                                         |     |     |     |         |
| $T_{PD-HL}$          | Propagation delay time, high-to-low                     | $V_{OD} = 10\text{ mV}$ , $C_L = 25\text{ pF}$ , $V_{STEP} = 100\text{ mV}$                             |     | 45  |     | $\mu s$ |
|                      |                                                         | $V_{OD} = 50\text{ mV}$ , $C_L = 25\text{ pF}$ , $V_{STEP} = 100\text{ mV}$                             |     | 16  |     | $\mu s$ |
|                      |                                                         | $V_{OD} = 100\text{ mV}$ , $C_L = 25\text{ pF}$ , $V_{STEP} = 200\text{ mV}$                            |     | 13  |     | $\mu s$ |
| $T_{PD-LH}$          | Propagation delay time, low-to-high (Push-Pull output)  | $V_{OD} = 10\text{ mV}$ , $C_L = 10\text{ pF}$ , $V_{STEP} = 100\text{ mV}$                             |     | 34  |     | $\mu s$ |
| $T_{PD-LH}$          | Propagation delay time, low-to-high (Push-Pull output)  | $V_{OD} = 50\text{ mV}$ , $C_L = 10\text{ pF}$ , $V_{STEP} = 100\text{ mV}$                             |     | 16  |     | $\mu s$ |
| $T_{PD-LH}$          | Propagation delay time, low-to-high (Push-Pull output)  | $V_{OD} = 100\text{ mV}$ , $C_L = 10\text{ pF}$ , $V_{STEP} = 200\text{ mV}$                            |     | 14  |     | $\mu s$ |
| $T_{PD-LH}$          | Propagation delay time, low-to-high (Open-Drain output) | $V_{OD} = 10\text{ mV}$ , $C_L = 25\text{ pF}$ , $R_P = 1\text{ M}\Omega$ , $V_{STEP} = 100\text{ mV}$  |     | 57  |     | $\mu s$ |
|                      |                                                         | $V_{OD} = 50\text{ mV}$ , $C_L = 25\text{ pF}$ , $R_P = 1\text{ M}\Omega$ , $V_{STEP} = 100\text{ mV}$  |     | 36  |     | $\mu s$ |
|                      |                                                         | $V_{OD} = 100\text{ mV}$ , $C_L = 25\text{ pF}$ , $R_P = 1\text{ M}\Omega$ , $V_{STEP} = 200\text{ mV}$ |     | 35  |     | $\mu s$ |
| $T_{RISE}$           | Output Rise Time, 20% to 80%, push-pull output          | $C_L = 25\text{ pF}$                                                                                    |     | 0.2 |     | $\mu s$ |
| $T_{FALL}$           | Output Fall Time, 80% to 20%                            | $C_L = 25\text{ pF}$                                                                                    |     | 0.2 |     | $\mu s$ |
| <b>POWER ON TIME</b> |                                                         |                                                                                                         |     |     |     |         |
| $T_{ON}$             | Power on-time                                           |                                                                                                         |     | 3   |     | ms      |

## 6.7 Typical Characteristics

At  $T_A = 25^\circ\text{C}$ ,  $V_S = 12\text{ V}$ ,  $V_{CM} = V_S/2\text{ V}$ ,  $R_P = 1\text{ M}\Omega$  (Open Drain only),  $C_L = 25\text{ pF}$ ,  $V_{OVERDRIVE} = 100\text{ mV}$  unless otherwise noted.

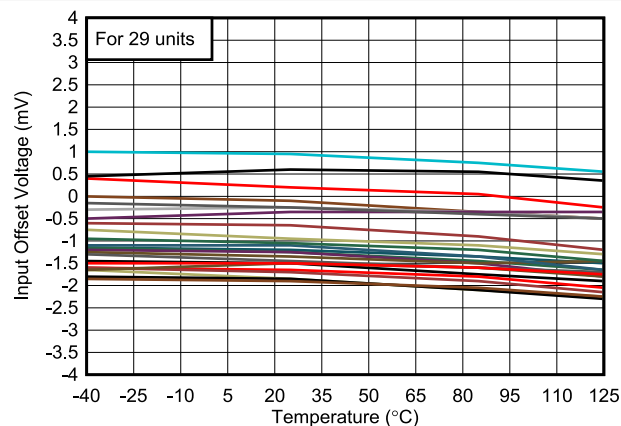


图 6-1. Offset vs. Temperature

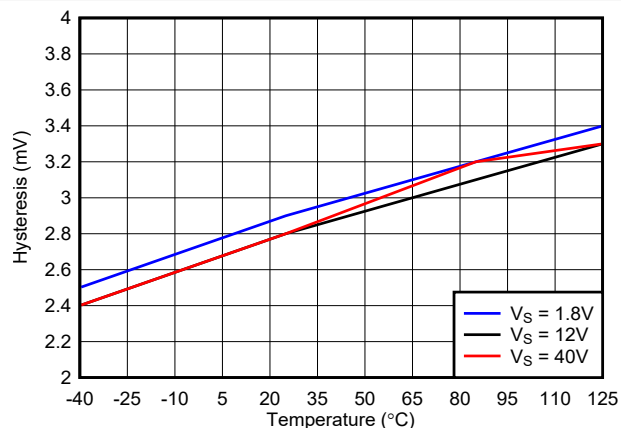


图 6-2. Hysteresis vs. Temperature

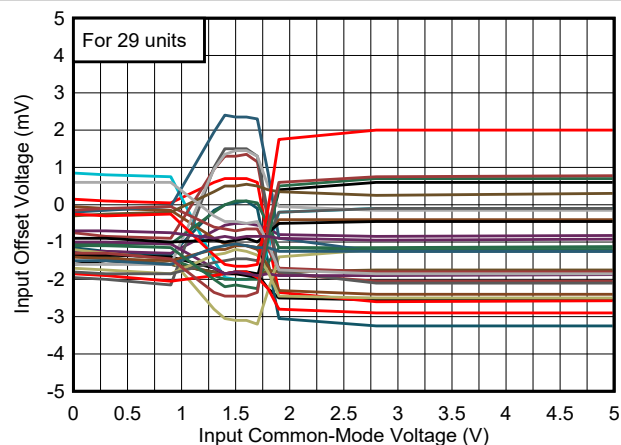


图 6-3. Offset vs. Common-Mode, 1.8 V

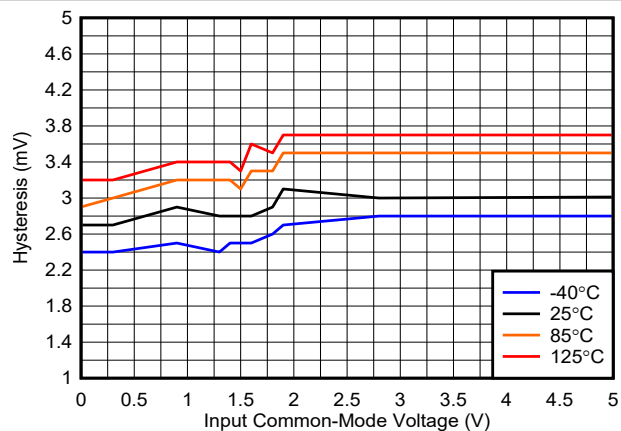


图 6-4. Hysteresis vs. Common-Mode, 1.8 V

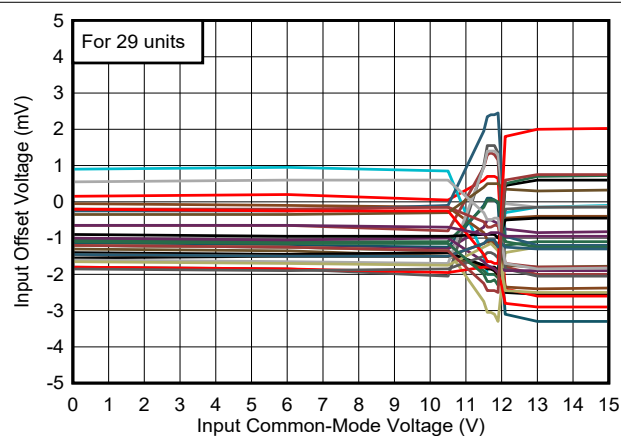


图 6-5. Offset vs. Common-Mode, 12 V

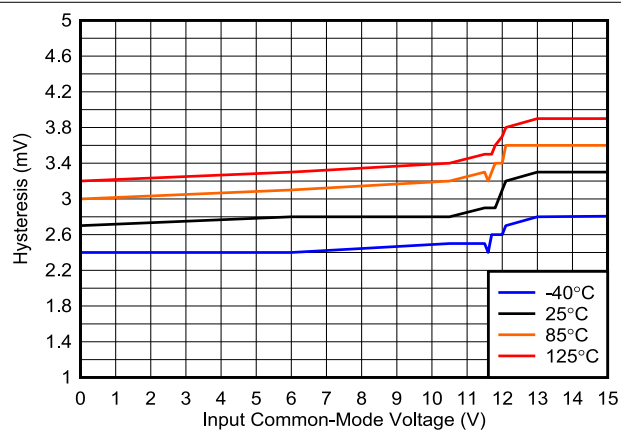


图 6-6. Hysteresis vs. Common-Mode, 12 V

## 6.7 Typical Characteristics (continued)

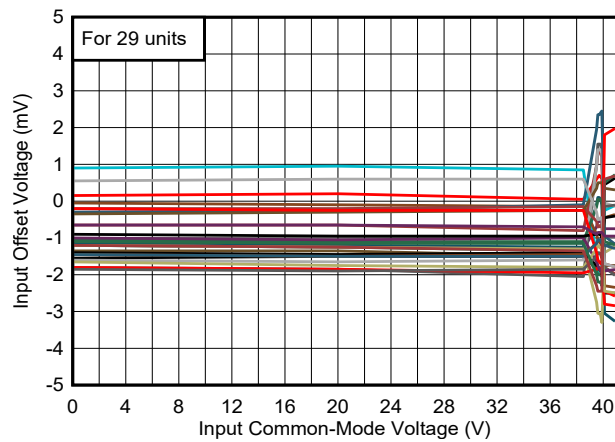


图 6-7. Offset vs. Common-Mode, 40 V

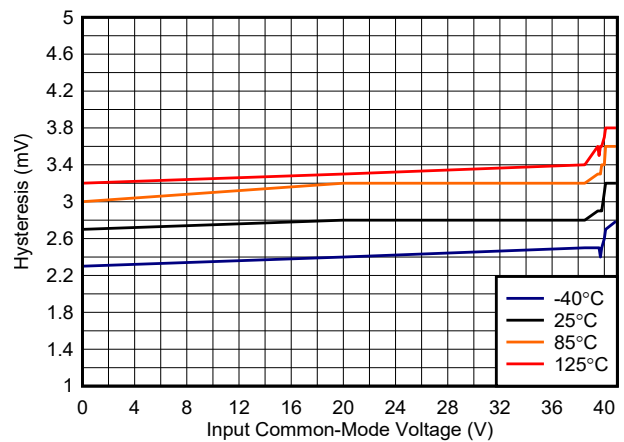


图 6-8. Hysteresis vs. Common-Mode, 40 V

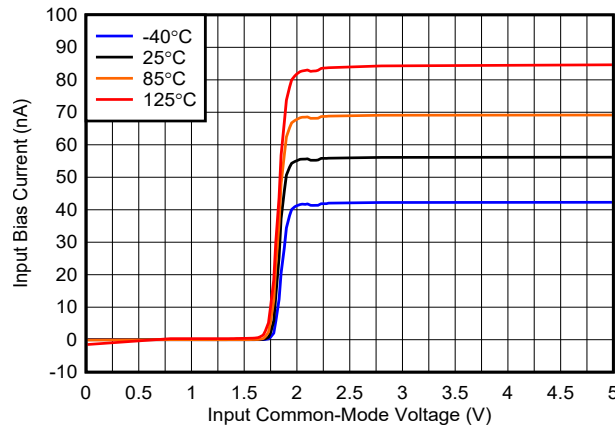


图 6-9. Bias Current vs. Common-Mode, 1.8 V

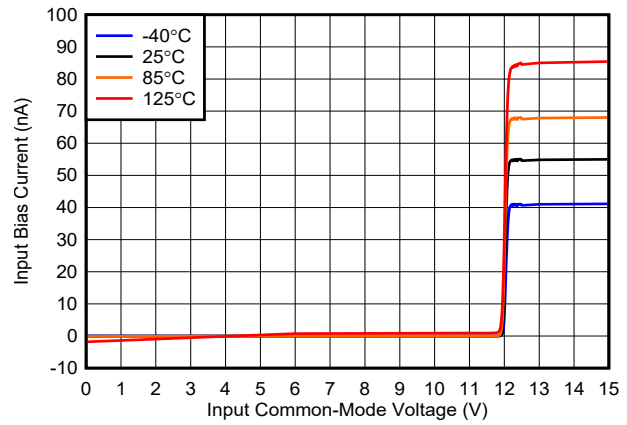


图 6-10. Bias Current vs. Common-Mode, 12 V

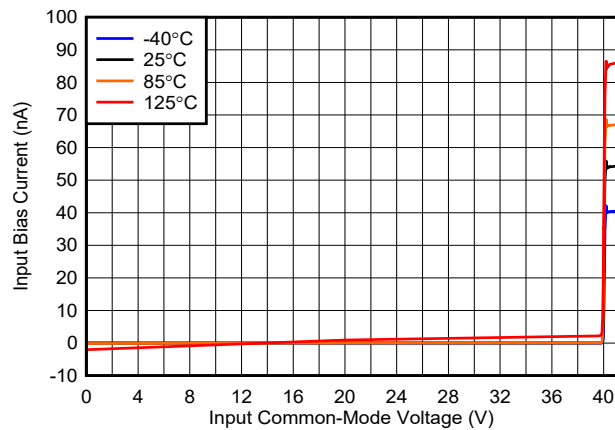


图 6-11. Bias Current vs. Common-Mode, 40 V

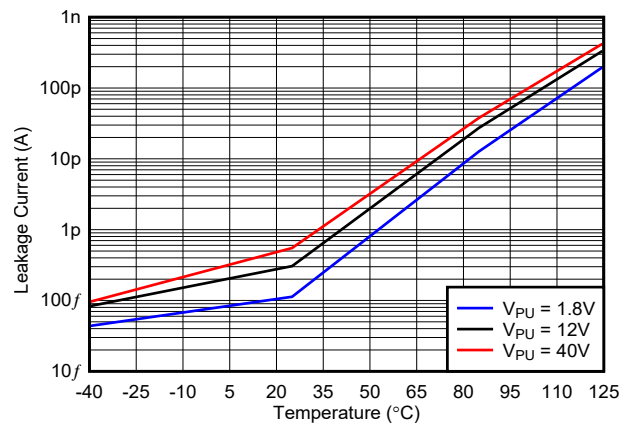


图 6-12. Leakage Current vs. Temperature (Open Drain only)

## 6.7 Typical Characteristics (continued)

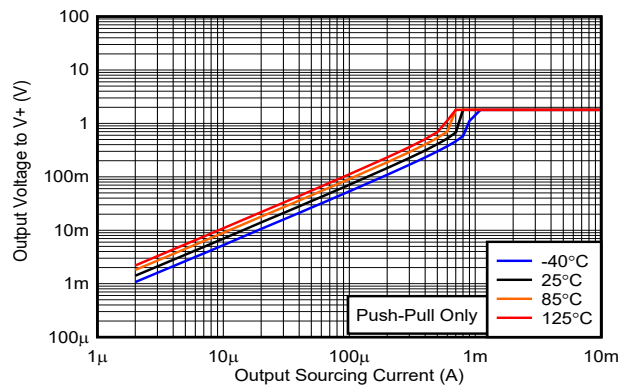


图 6-13. Output Voltage vs. Output Sourcing Current, 1.8V

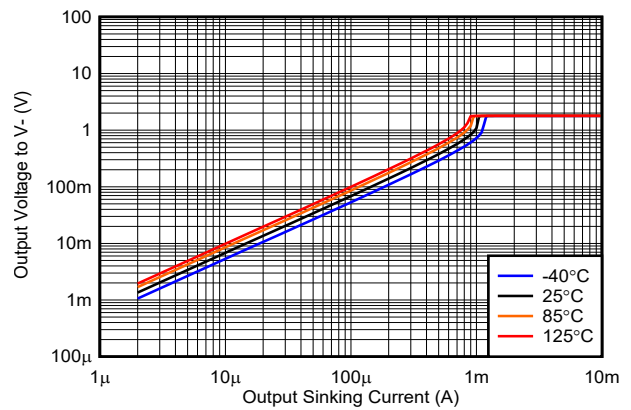


图 6-14. Output Voltage vs. Output Sinking Current, 1.8 V

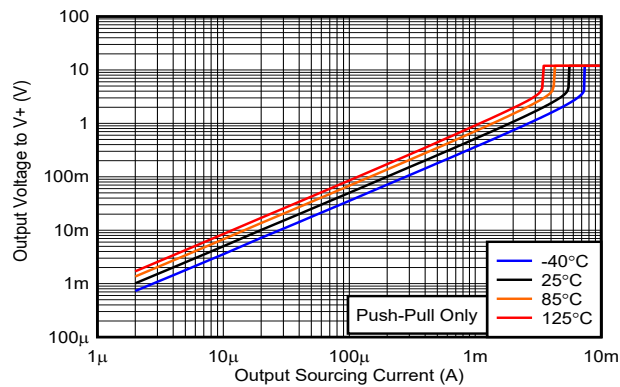


图 6-15. Output Voltage vs. Output Sourcing Current, 12V

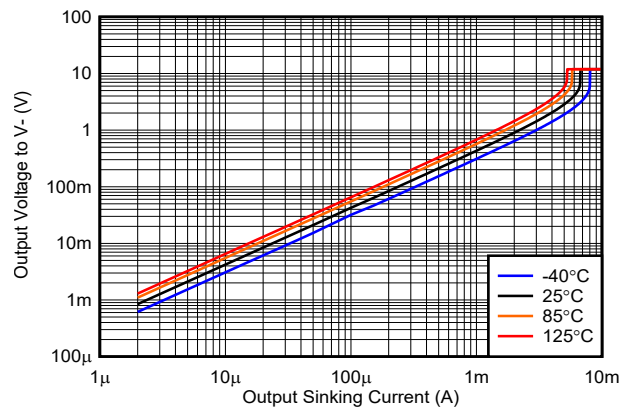


图 6-16. Output Voltage vs. Output Sinking Current, 12 V

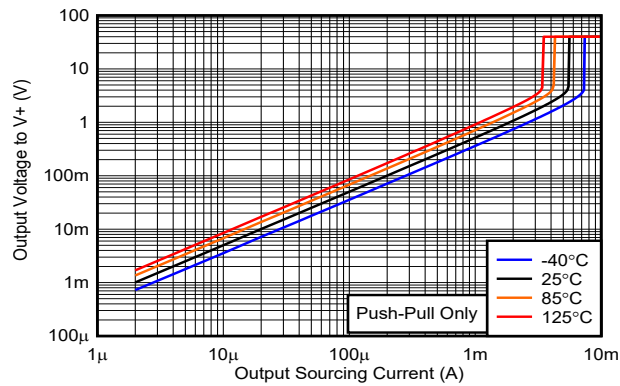


图 6-17. Output Voltage vs. Output Sourcing Current, 40V

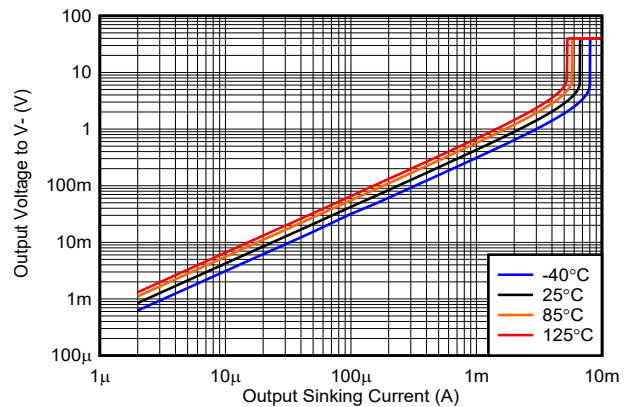
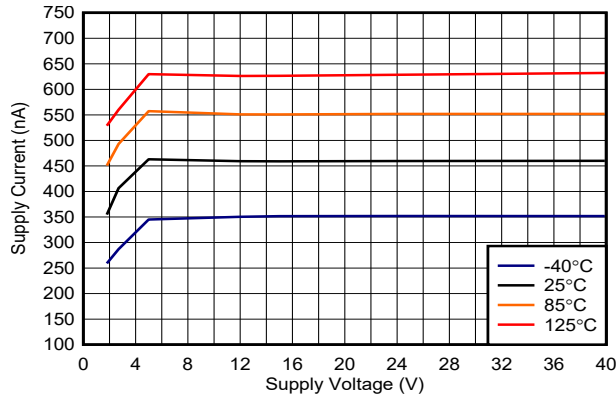
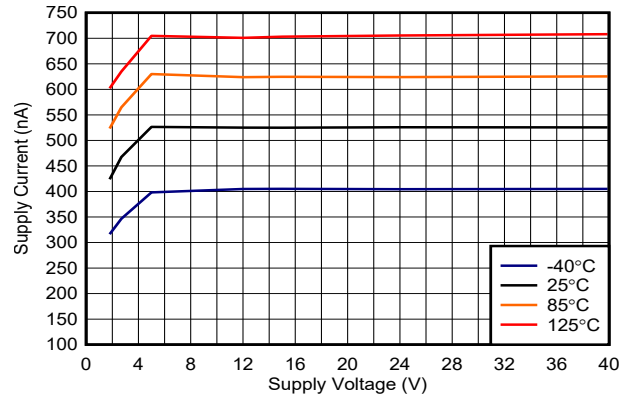


图 6-18. Output Voltage vs. Output Sinking Current, 40 V

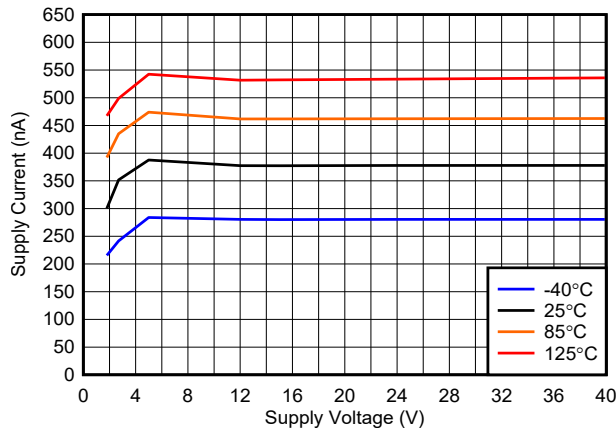
## 6.7 Typical Characteristics (continued)



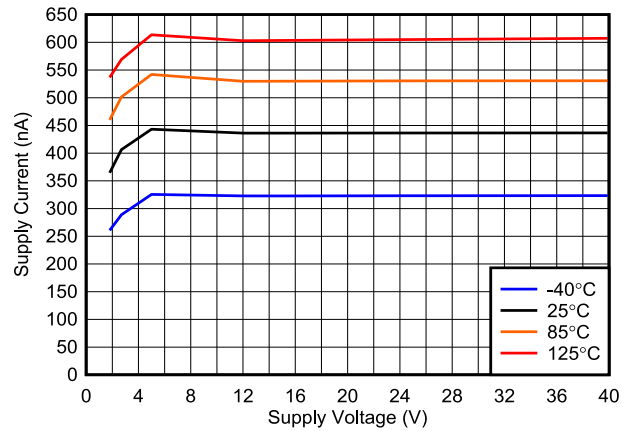
**FIG 6-19. Supply Current vs. Supply Voltage (Output Low), Push-Pull**



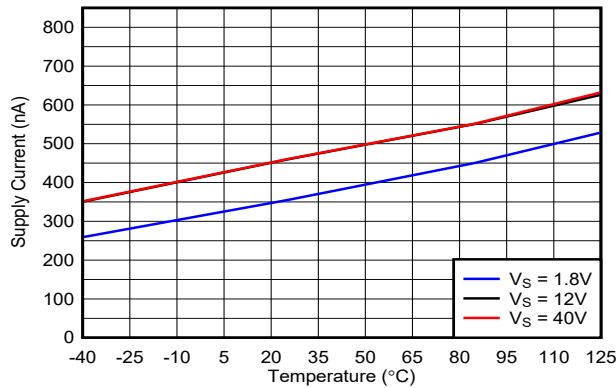
**FIG 6-20. Supply Current vs. Supply Voltage (Output High), Push-Pull**



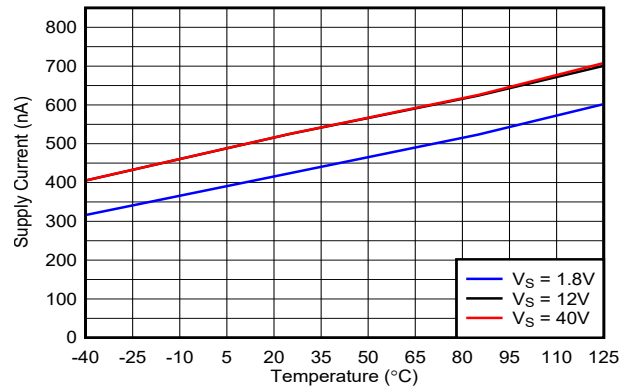
**FIG 6-21. Supply Current vs. Supply Voltage (Output Low), Open Drain**



**FIG 6-22. Supply Current vs. Supply Voltage (Output High), Open Drain**



**FIG 6-23. Supply Current vs. Temperature (Output Low), Push-Pull**



**FIG 6-24. Supply Current vs. Temperature (Output High), Push-Pull**

## 6.7 Typical Characteristics (continued)

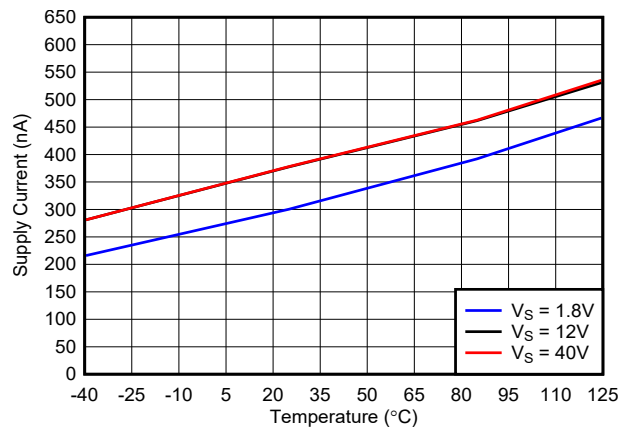


图 6-25. Supply Current vs. Temperature (Output Low), Open Drain

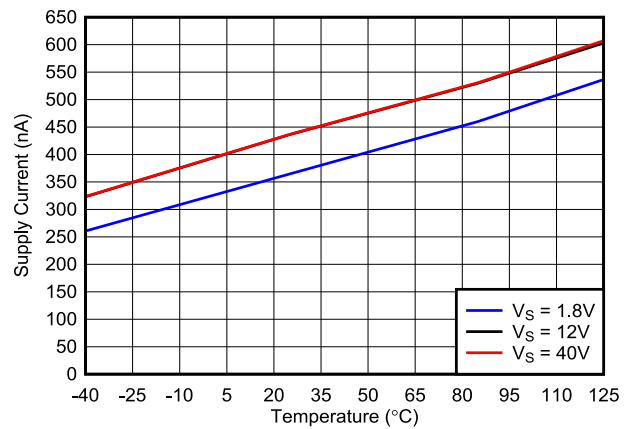


图 6-26. Supply Current vs. Temperature (Output High), Open Drain

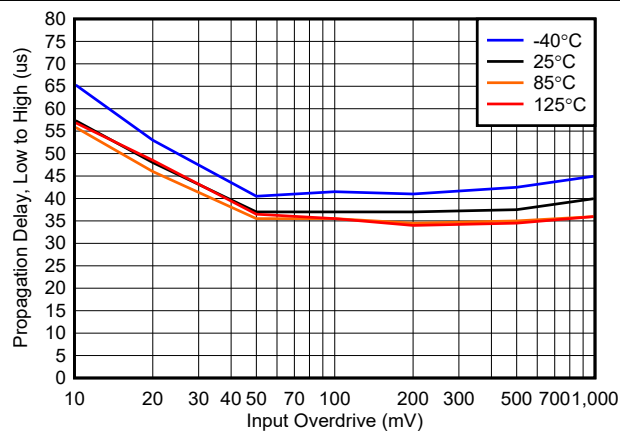


图 6-27. Propagation Delay, Low to High, 1.8 V, Open Drain

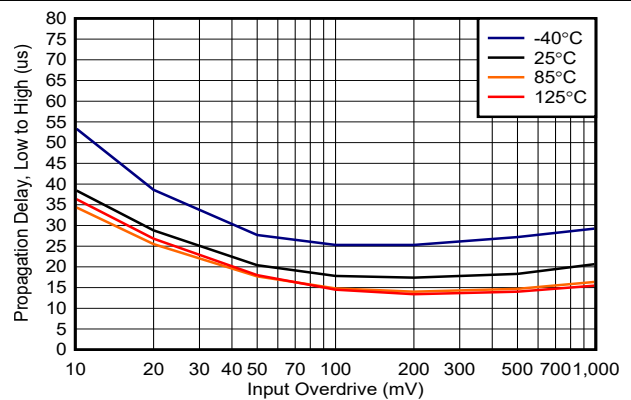


图 6-28. Propagation Delay, Low to High, 1.8 V, Push-Pull

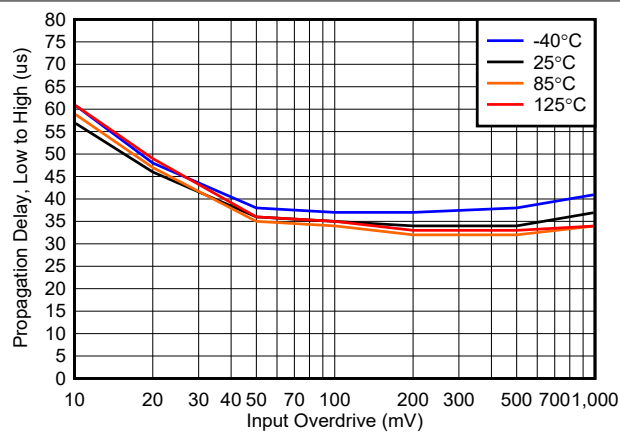


图 6-29. Propagation Delay, Low to High, 12 V, Open Drain

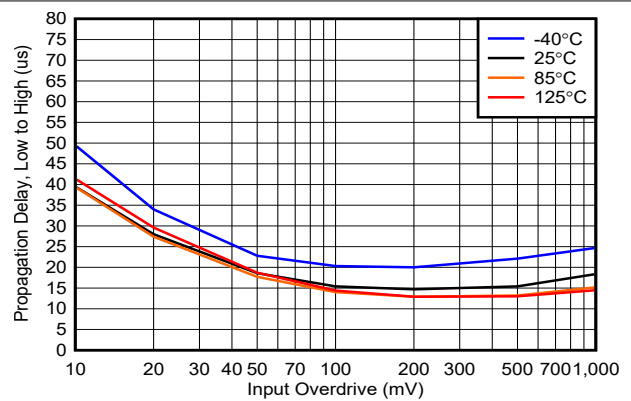


图 6-30. Propagation Delay, Low to High, 12 V, Push-Pull

## 6.7 Typical Characteristics (continued)

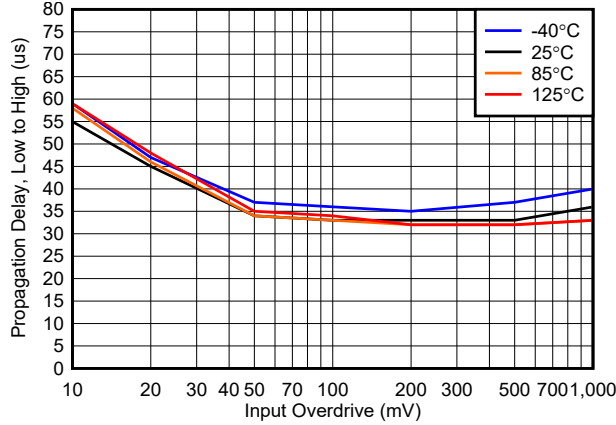


图 6-31. Propagation Delay, Low to High, 40 V, Open Drain

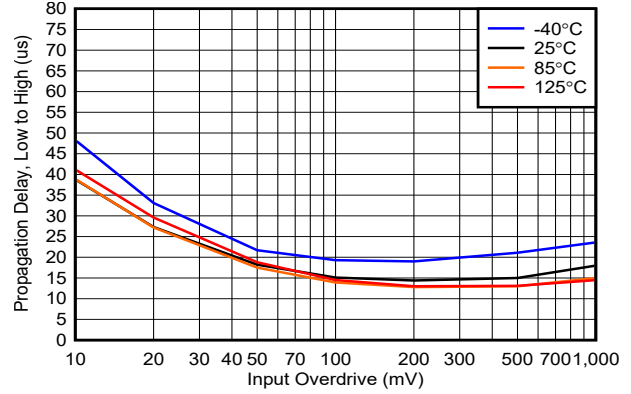


图 6-32. Propagation Delay, Low to High, 40 V, Push-Pull

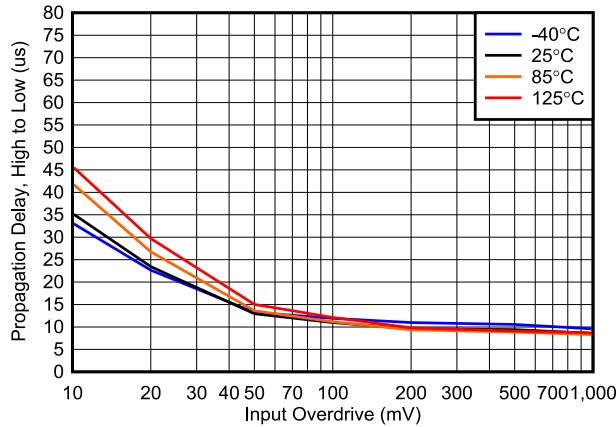


图 6-33. Propagation Delay, High to Low, 1.8 V

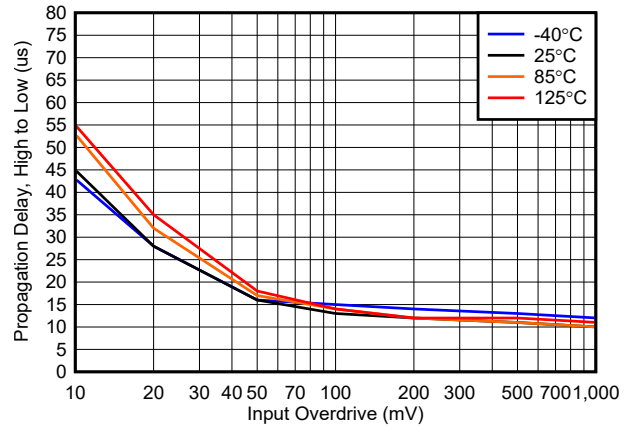


图 6-34. Propagation Delay, High to Low, 12 V

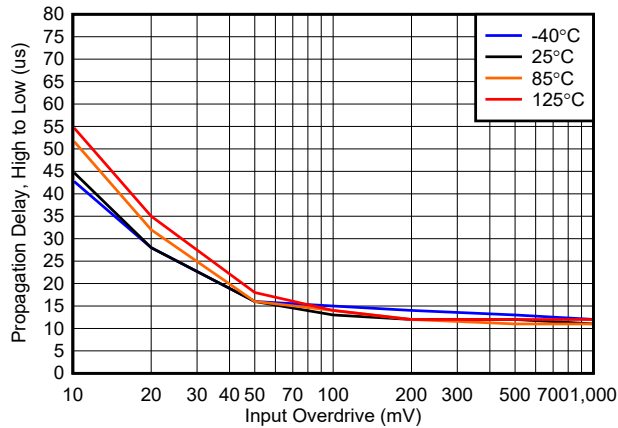


图 6-35. Propagation Delay, High to Low, 40 V

## 7 Detailed Description

### 7.1 Overview

The TLV185x-Q1 and TLV186x-Q1 devices are nanopower comparators with push-pull and open-drain output options. Operating down to 1.8 V while only consuming only 440 nA per channel, the TLV185x-Q1 and TLV186x-Q1 are well suited for voltage, current, and temperature sensing in low and high voltage low-power, always-on systems. An internal power-on reset circuit ensures that the output remains in a known state during power-up and power-down. Inputs have fail-safe inputs that can tolerate input transients without damage or false outputs.

### 7.2 Functional Block Diagrams

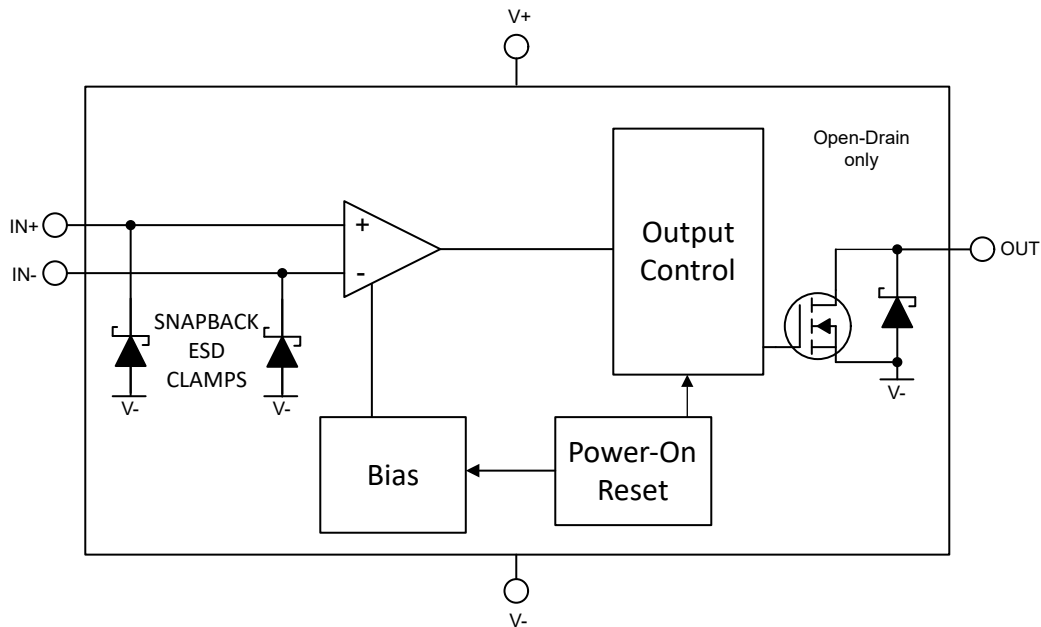


图 7-1. Block Diagram

### 7.3 Feature Description

The TLV185x-Q1 (push-pull output) and TLV186x-Q1 (open-drain output) devices are nano-power comparators that are capable of operating at high voltages. This family of comparators feature a fail safe input stage and over the rail operating condition mode capable of operating up to 40 V, independent of  $V_+$ . The comparators also have an internal reverse battery protection feature and Power-On-Reset for known start-up conditions.

### 7.4 Device Functional Modes

#### 7.4.1 Inputs

##### 7.4.1.1 Operating Common-Mode Ranges

The TLV185x-Q1 and TLV186x-Q1 devices have two operating common-mode ranges: within-the-rail and over-the-rail.

##### Within-the-Rail Operation: $IN+$ and $IN-$ are less than $(V_+)$

When an input pin is operating less than  $(V_+)$ , there are two operating regions defined where input voltages can be compared: low common-mode and high-common mode. In low-common mode which extends typically from 0 V to  $(V_+) - 1$  V, the typical input bias current is less than 1 pA. In high common-mode which extends typically from  $(V_+) - 1$  V to  $(V_+)$ , the typical input bias current is less than 14 nA.

##### Over-the-Rail Operation: $IN+$ and/or $IN-$ are greater than $(V_+)$

The TLV185x-Q1 and TLV186x-Q1 devices have a distinctive input stage that allows the input common mode range to extend from 0 V to 40 V independent of the supply voltage. This feature means that operation at low

supply voltages does not limit the range of input voltages that can be compared. When an input pin is operating over-the-rail (above (V+)), the bias current increases to a typical value of 55 nA.

See Figure 6-9 to 6-11 in the [Typical Characteristics](#) section for input bias current vs. common-mode voltages.

#### 7.4.1.2 Fail-Safe Inputs

A feature of the TLV185x-Q1 and TLV186x-Q1 family is that the inputs are fail safe up to 40 V, independent of (V+). The inputs are maintained as high input impedance and can be of any value between -0.1 V and 40 V, even while (V+) is unpowered or below the minimum supply voltage. This feature avoids power sequencing or transient issues since the inputs are not diode clamped to (V+).

#### 7.4.1.3 Unused Inputs

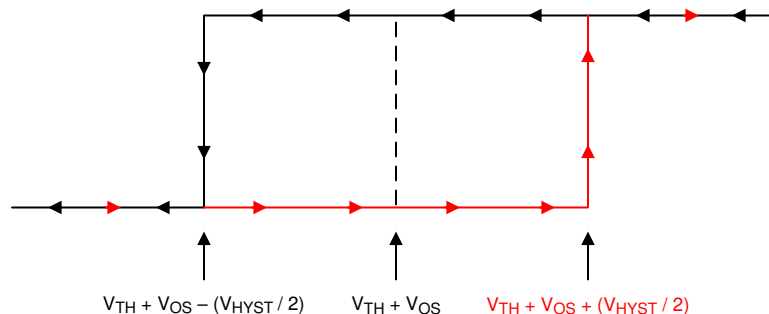
If a channel is not to be used, DO NOT tie the inputs together. Due to the high equivalent bandwidth and low offset voltage, tying the inputs directly together can cause high frequency oscillations as the device triggers on it's own internal wideband noise. Instead, the inputs should be tied to any available voltage that resides within the specified input voltage range and provides a minimum of 50mV differential voltage. For example, one input can be grounded and the other input connected to a reference voltage, or even (V+).

#### 7.4.2 Internal Hysteresis

The device hysteresis transfer curve is shown in [图 7-2](#). This curve is a function of three components:  $V_{TH}$ ,  $V_{OS}$ , and  $V_{HYST}$ :

- $V_{TH}$  is the actual set voltage or threshold trip voltage.
- $V_{OS}$  is the internal offset voltage between  $V_{IN+}$  and  $V_{IN-}$ . This voltage is added to  $V_{TH}$  to form the actual trip point at which the comparator must respond to change output states.
- $V_{HYST}$  is the internal hysteresis (or trip window) that is designed to reduce comparator sensitivity to noise.

(2.8 mV for the TLV185x/6x family)



**图 7-2. Hysteresis Transfer Curve**

#### 7.4.3 Outputs

##### 7.4.3.1 TLV185x-Q1 Push-Pull Output

The TLV185x-Q1 features a push-pull output stage capable of both sinking and sourcing current. This allows driving loads such as LED's and MOSFET gates, as well as eliminating the need for a power-wasting external pull-up resistor. The push-pull output must never be connected to another output.

Directly shorting the output to the supply rails ((V+) when output "low" or (V-) when output "High") can result in thermal runaway and eventual device destruction at high (>12 V) supply voltages. If output shorts are possible, a series current limiting resistor is recommended to limit the power dissipation.

Unused push-pull outputs should be left floating, and never tied to a supply, ground, or another output.

##### 7.4.3.2 TLV186x-Q1 Open-Drain Output

The TLV186x-Q1 features an open-drain (also commonly called open collector) sinking-only output stage enabling the output logic levels to be pulled up to an external voltage from 0 V up to 40 V, independent of the comparator supply voltage (V+). The open-drain output also allows logical OR'ing of multiple open drain

outputs and logic level translation. TI recommends setting the pull-up resistor current to less than 100  $\mu$ A to optimize  $V_{OL}$  logic levels. Lower pull-up resistor values will help increase the rising edge risetime, but at the expense of increasing  $V_{OL}$  and higher power dissipation. The risetime will be dependent on the time constant of the total pull-up resistance and total load capacitance. Large value pull-up resistors ( $>1$  M $\Omega$ ) will create an exponential rising edge due to the output RC time constant and increase the risetime.

Directly shorting the output to (V+) can result in thermal runaway and eventual device destruction at high ( $>12$  V) pull-up voltages. If output shorts are possible, a series current limiting resistor is recommended to limit the power dissipation.

Unused open drain outputs should be left floating, or can be tied to the (V-) pin if floating pins are not desired.

## 7.4.4 ESD Protection

### 7.4.4.1 Inputs

The fail-safe inputs incorporate internal ESD protection circuits on all pins. The fail-safe inputs have ESD protection from each pin to (V-) which allows these pins to exceed the supply voltage (V+) up to 40 V. If input voltages are to exceed 40 V, an external clamp would be required. Likewise, negative voltages on the inputs are ESD clamped to (V-) and should be limited to less than -0.1 V.

If the inputs are to be connected to a low impedance source, such as a power supply or buffered reference line, TI recommends adding a current-limiting resistor in series with the input to limit any transient currents should the clamps conduct. The current should be limited to 10 mA or less. This series resistance can be part of any resistive input dividers or networks.

### 7.4.4.2 Outputs

The TLV185x-Q1 push-pull output protection also contains a conventional diode-type ESD clamps between the output and (V-), as the output should not exceed the supply rails.

The TLV186x-Q1 open-drain output ESD protection also consists of a snapback ESD clamp between the output and (V-) to allow the output to be pulled above (V+) to a maximum of 40 V.

## 7.4.5 Power-On Reset (POR)

The TLV185x-Q1 and TLV186x-Q1 devices have an internal Power-on-Reset (POR) circuit for known start-up or power-down conditions. While the power supply (V+) is ramping up or ramping down, the POR circuitry will be activated for up to 2 ms after the  $V_{POR}$  of 1.5 V is crossed. When the supply voltage is equal to or greater than the minimum supply voltage, and after the delay period, the comparator output reflects the state of the differential input ( $V_{ID}$ ).

For the TLV185x-Q1 push-pull output devices, the output is held low during the POR period ( $t_{on}$ ).

For the TLV186x-Q1 open drain output devices, the POR circuit will keep the output high impedance (Hi-Z) during the POR period ( $t_{on}$ ).

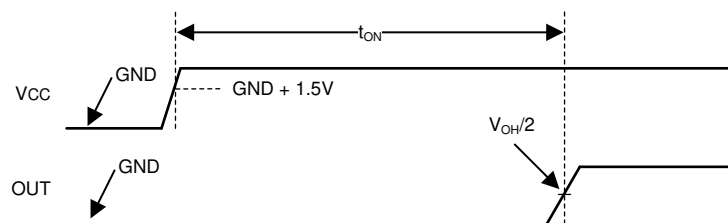


图 7-3. Power-On Reset Timing Diagram

Note that it the nature of an open collector output that the output will rise with the pull-up voltage during the POR period.

#### 7.4.6 Reverse Battery Protection

The TLV185x-Q1 and TLV186x-Q1 devices have an internal reverse battery protection feature that prevents damage to the comparator in the event of improper battery installation to the supply pins. This protection feature works up to 40 V.

## 8 Application and Implementation

### 备注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

#### 8.1.1 Basic Comparator Definitions

##### 8.1.1.1 Operation

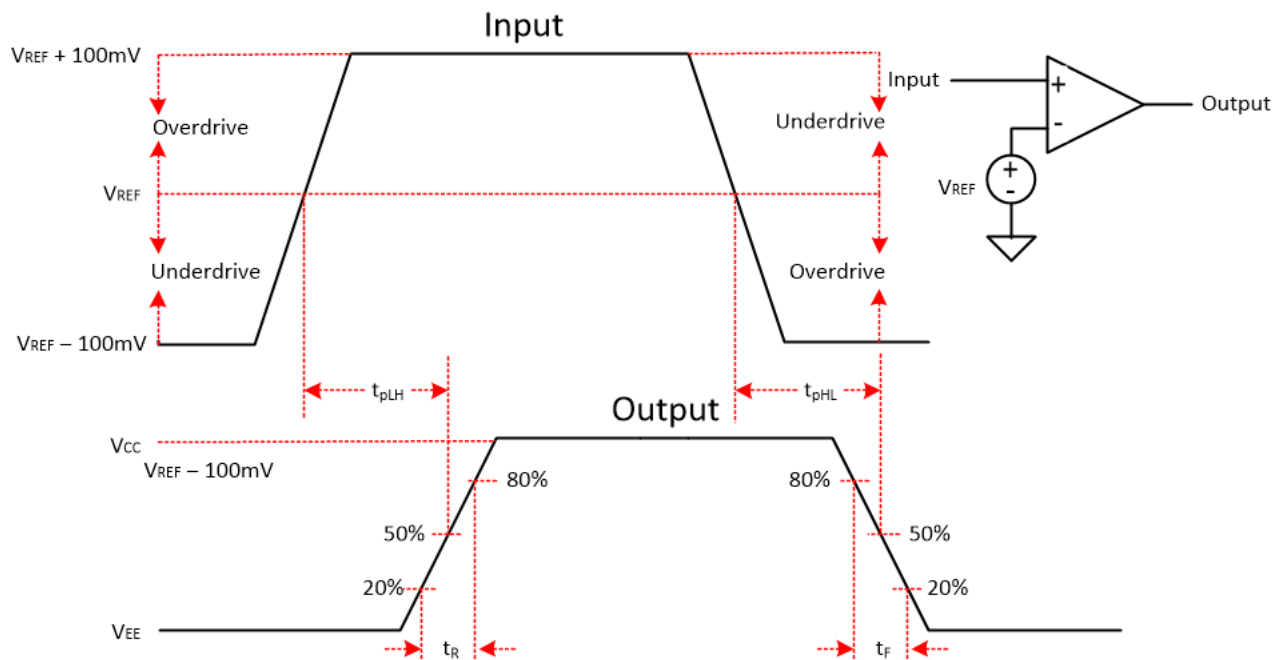
The basic comparator compares the input voltage ( $V_{IN}$ ) on one input to a reference voltage ( $V_{REF}$ ) on the other input. In the [图 8-1](#) example below, if  $V_{IN}$  is less than  $V_{REF}$ , the output voltage ( $V_O$ ) is logic low ( $V_{OL}$ ). If  $V_{IN}$  is greater than  $V_{REF}$ , the output voltage ( $V_O$ ) is at logic high ( $V_{OH}$ ). [表 8-1](#) summarizes the output conditions. The output logic can be inverted by simply swapping the input pins.

**表 8-1. Output Conditions**

| Inputs Condition | Output                                                     |
|------------------|------------------------------------------------------------|
| $IN+ > IN-$      | HIGH ( $V_{OH}$ )                                          |
| $IN+ = IN-$      | Indeterminate (chatters - see <a href="#">Hysteresis</a> ) |
| $IN+ < IN-$      | LOW ( $V_{OL}$ )                                           |

##### 8.1.1.2 Propagation Delay

There is a delay between from when the input crosses the reference voltage and the output responds. This is called the Propagation Delay. Propagation delay can be different between high-to-low and low-to-high input transitions. This is shown as  $t_{pLH}$  and  $t_{pHL}$  in [图 8-1](#) and is measured from the mid-point of the input to the midpoint of the output.



**图 8-1. Comparator Timing Diagram**

### 8.1.1.3 Overdrive Voltage

The overdrive voltage,  $V_{OD}$ , is the amount of input voltage beyond the reference voltage (and not the total input peak-to-peak voltage). The overdrive voltage is 100 mV as shown in the 图 8-1 example. The overdrive voltage can influence the propagation delay ( $t_p$ ). The smaller the overdrive voltage, the longer the propagation delay, particularly when  $<100\text{mV}$ . If the fastest speeds are desired, it is recommended to apply the highest amount of overdrive possible.

The risetime ( $t_r$ ) and falltime ( $t_f$ ) is the time from the 20% and 80% points of the output waveform.

### 8.1.2 Hysteresis

The basic comparator configuration may produce a noisy "chatter" output if the applied differential input voltage is near the comparator's offset voltage. This usually occurs when the input signal is moving very slowly across the switching threshold of the comparator. This problem can be prevented by adding external hysteresis to the comparator.

Since the TLV185x-Q1 and TLV186x-Q1 devices only have a minimal amount of internal hysteresis of 2.7 mV, external hysteresis can be applied in the form of a positive feedback loop that adjusts the trip point of the comparator depending on its current output state.

The hysteresis transfer curve is shown in 图 8-2. This curve is a function of three components:  $V_{TH}$ ,  $V_{OS}$ , and  $V_{HYST}$ :

- $V_{TH}$  is the actual set voltage or threshold trip voltage.
- $V_{OS}$  is the internal offset voltage between  $V_{IN+}$  and  $V_{IN-}$ . This voltage is added to  $V_{TH}$  to form the actual trip point at which the comparator must respond to change output states.
- $V_{HYST}$  is the hysteresis (or trip window) that is designed to reduce comparator sensitivity to noise.

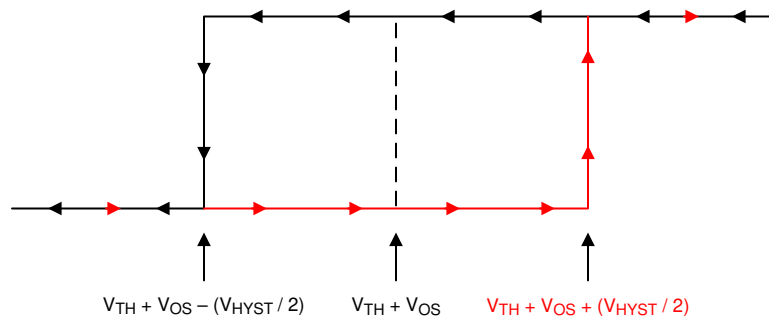


图 8-2. Hysteresis Transfer Curve

For more information, please see Application Note SBOA219 "Comparator with and without hysteresis circuit".

#### 8.1.2.1 Inverting Comparator With Hysteresis

The inverting comparator with hysteresis requires a three-resistor network that is referenced to the comparator supply voltage ( $V_{CC}$ ), as shown in 图 8-3.

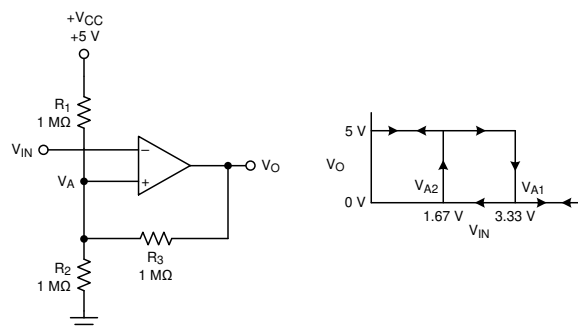


图 8-3. TLV185x-Q1 in an Inverting Configuration With Hysteresis

The equivalent resistor networks when the output is high and low are shown in 图 8-3.

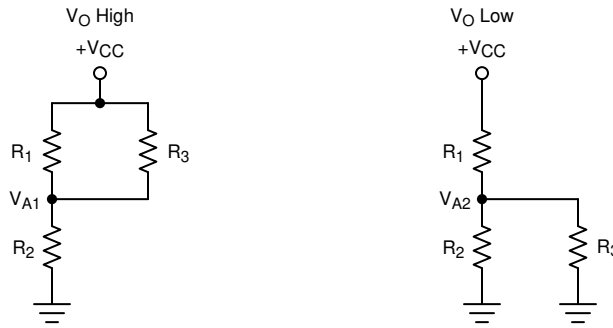


图 8-4. Inverting Configuration Resistor Equivalent Networks

When  $V_{IN}$  is less than  $V_A$ , the output voltage is high (for simplicity, assume  $V_O$  switches as high as  $V_{CC}$ ). The three network resistors can be represented as  $R1 \parallel R3$  in series with  $R2$ , as shown in 图 8-4.

方程式 1 below defines the high-to-low trip voltage ( $V_{A1}$ ).

$$V_{A1} = V_{CC} \times \frac{R2}{(R1 \parallel R3) + R2} \quad (1)$$

When  $V_{IN}$  is greater than  $V_A$ , the output voltage is low. In this case, the three network resistors can be presented as  $R2 \parallel R3$  in series with  $R1$ , as shown in 方程式 2.

Use 方程式 2 to define the low to high trip voltage ( $V_{A2}$ ).

$$V_{A2} = V_{CC} \times \frac{R2 \parallel R3}{R1 + (R2 \parallel R3)} \quad (2)$$

方程式 3 defines the total hysteresis provided by the network.

$$\Delta V_A = V_{A1} - V_{A2} \quad (3)$$

### 8.1.2.2 Non-Inverting Comparator With Hysteresis

A non-inverting comparator with hysteresis requires a two-resistor network and a voltage reference ( $V_{REF}$ ) at the inverting input, as shown in 图 8-5,

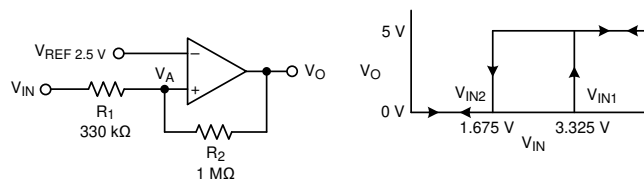
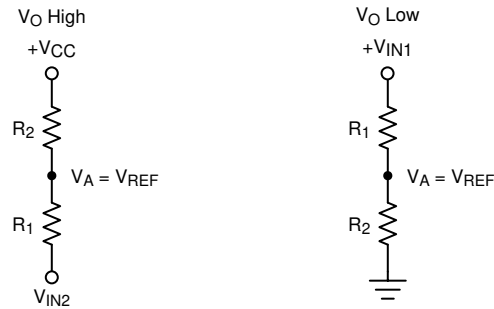


图 8-5. TLV185x-Q1 in a Non-Inverting Configuration With Hysteresis

The equivalent resistor networks when the output is high and low are shown in 图 8-6.



**图 8-6. Non-Inverting Configuration Resistor Networks**

When  $V_{IN}$  is less than  $V_{REF}$ , the output is low. For the output to switch from low to high,  $V_{IN}$  must rise above the  $V_{IN1}$  threshold. Use [方程式 4](#) to calculate  $V_{IN1}$ .

$$V_{IN1} = R1 \times \frac{V_{REF}}{R2} + V_{REF} \quad (4)$$

When  $V_{IN}$  is greater than  $V_{REF}$ , the output is high. For the comparator to switch back to a low state,  $V_{IN}$  must drop below  $V_{IN2}$ . Use [方程式 5](#) to calculate  $V_{IN2}$ .

$$V_{IN2} = \frac{V_{REF} (R1 + R2) - V_{CC} \times R1}{R2} \quad (5)$$

The hysteresis of this circuit is the difference between  $V_{IN1}$  and  $V_{IN2}$ , as shown in [方程式 6](#).

$$\Delta V_{IN} = V_{CC} \times \frac{R1}{R2} \quad (6)$$

For more information, please see Application Notes SNOA997 "[Inverting comparator with hysteresis circuit](#)" and SBOA313 "[Non-Inverting Comparator With Hysteresis Circuit](#)".

### 8.1.2.3 Inverting and Non-Inverting Hysteresis using Open-Drain Output

It is also possible to use an open drain output device, such as the TLV186x-Q1, but the output pull-up resistor must also be taken into account in the calculations. The pull-up resistor is seen in series with the feedback resistor when the output is high. Thus, the feedback resistor is actually seen as  $R2 + R_{PULLUP}$ . TI recommends that the pull-up resistor be at least 10 times less than the feedback resistor value.

## 8.2 Typical Applications

### 8.2.1 Window Comparator

Window comparators are commonly used to detect undervoltage and overvoltage conditions. [图 8-7](#) shows a simple window comparator circuit. Window comparators require open drain outputs (TLV186x-Q1 if the outputs are directly connected together).

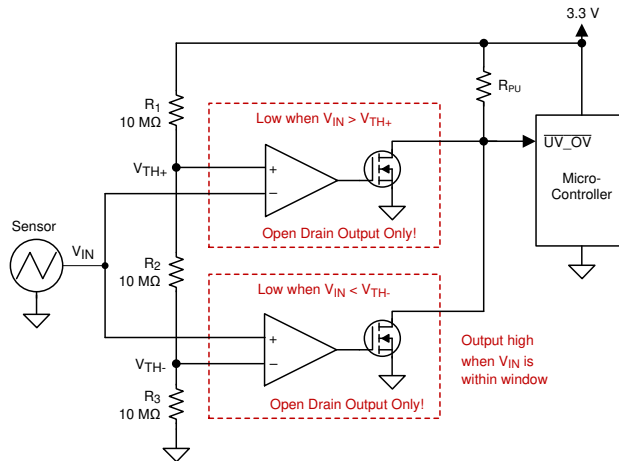


图 8-7. Window Comparator

### 8.2.1.1 Design Requirements

For this design, follow these design requirements:

- Alert (logic low output) when an input signal is less than 1.1 V
- Alert (logic low output) when an input signal is greater than 2.2 V
- Alert signal is active low
- Operate from a 3.3-V power supply

### 8.2.1.2 Detailed Design Procedure

Configure the circuit as shown in 图 8-7. Connect  $V_+$  to a 3.3-V power supply and  $V_{EE}$  to ground. Make  $R_1$ ,  $R_2$  and  $R_3$  each 10-M $\Omega$  resistors. These three resistors are used to create the positive and negative thresholds for the window comparator ( $V_{TH+}$  and  $V_{TH-}$ ).

With each resistor being equal,  $V_{TH+}$  is 2.2 V and  $V_{TH-}$  is 1.1 V. Large resistor values such as 10-M $\Omega$  are used to minimize power consumption. The resistor values may be recalculated to provide the desired trip point values.

The sensor output voltage is applied to the inverting and noninverting inputs of the two comparators. Using two open-drain output comparators allows the two comparator outputs to be Wire-OR'ed together.

The respective comparator outputs will be low when the sensor is less than 1.1 V or greater than 2.2 V. The respective comparator outputs will be high when the sensor is in the range of 1.1 V to 2.2 V (within the "window"), as shown in 图 8-8.

### 8.2.1.3 Application Curve

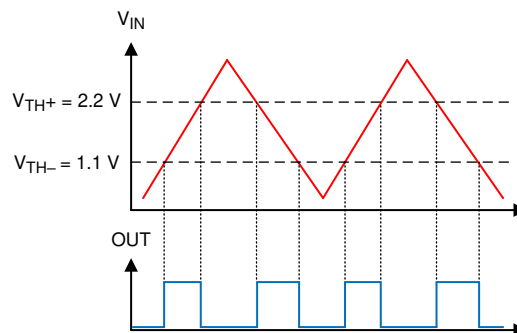


图 8-8. Window Comparator Results

For more information, please see Application note SBOA221 "[Window comparator circuit](#)".

## 8.2.2 Undervoltage Detection

Undervoltage detection is frequently required in low-power, always-on systems to alert the downstream device that a battery or supply voltage has drooped below the nominal voltage level. The TLV185x-Q1 and TLV186x-Q1 devices have an over-the-rail capability which allows the comparator to monitor high voltages up to 40 V on the inputs while operating at lower supply voltages such as 3.3 V, as shown in 图 8-9. The high voltage battery  $V_{BAT}$  is divided down to be compared against a reference voltage, which can be set by a shunt regulator such as the TL431. When the voltage on the non-inverting input drops below the reference voltage, then the output of the comparator will toggle and send an alert signal to a MCU.

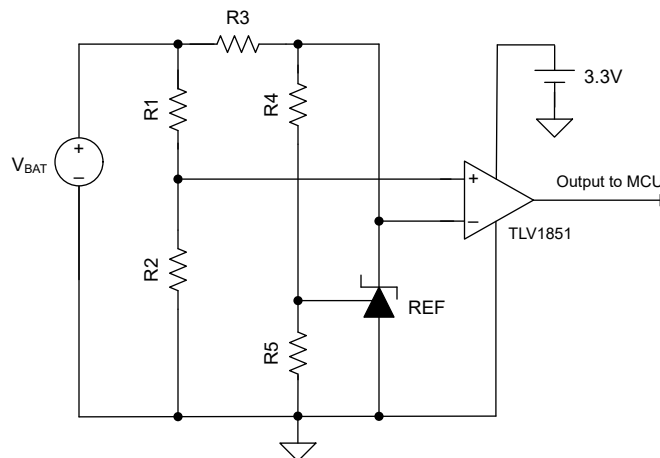


图 8-9. Undervoltage Detection

## 8.2.3 Reverse Battery and Overvoltage Protection Scheme

In battery powered applications, it is essential to have safeguards in place to protect the internal electronics against reverse battery connections. 图 8-10 shows a protection scheme using TLV1851-Q1 to prevent damage to the overall system in the events of both improper battery installation and overvoltage conditions. Under either of these instances, Q1 and Q2 will open, thus protecting the system from ever seeing reverse battery or overvoltage conditions.

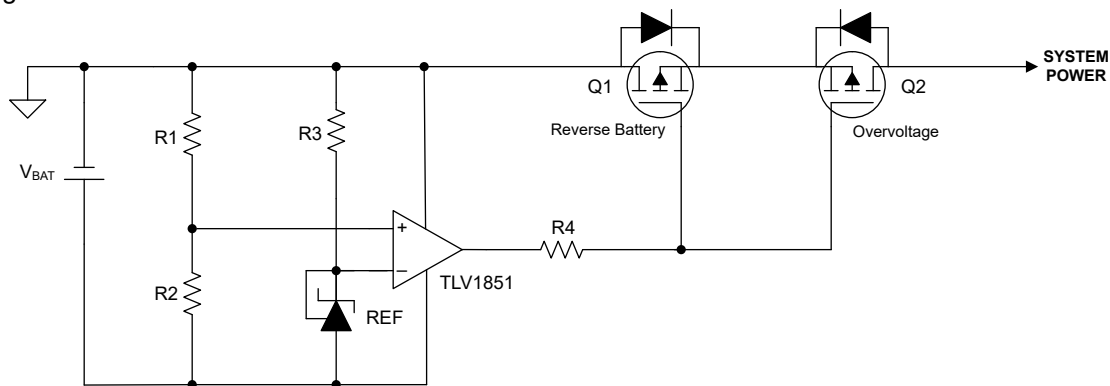


图 8-10. Reverse Battery and Overvoltage Protection Scheme

## 8.3 Power Supply Recommendations

Due to the fast output edges, it is critical to have bypass capacitors on the supply pin to prevent supply ringing and false triggers and oscillations. Bypass the supply directly at *each* device with a low ESR 0.1  $\mu$ F ceramic bypass capacitor directly between the (V+) pin and ground pins. Narrow peak currents will be drawn during the output transition time, particularly for the push-pull output device. These narrow pulses can cause un-bypassed supply lines and poor grounds to ring, possibly causing variation that can eat into the input voltage range and create an inaccurate comparison or even oscillations.

The device may be powered from both "split" supplies ((V+) & (V-)), or "single" supplies ((V+) and GND), with GND applied to the (V-) pin. Input signals must stay within the recommended input range for either type. Note that with a "split" supply the output will now swing "low" ( $V_{OL}$ ) to (V-) potential and not GND.

## 9 Layout

### 9.1 Layout Guidelines

For accurate comparator applications it is important maintain a stable power supply with minimized noise and glitches. Output rise and fall times are in the tens of nanoseconds, and should be treated as high speed logic devices. The bypass capacitor should be as close to the supply pin as possible and connected to a solid ground plane, and preferably directly between the (V+) and GND pins.

Minimize coupling between outputs and inputs to prevent output oscillations. Do not run output and input traces in parallel unless there is a (V+) or GND trace between output to reduce coupling. When series resistance is added to inputs, place resistor close to the device. A low value (<100 ohms) resistor may also be added in series with the output to dampen any ringing or reflections on long, non-impedance controlled traces. For best edge shapes, controlled impedance traces with back-terminations should be used when routing long distances.

### 9.2 Layout Example

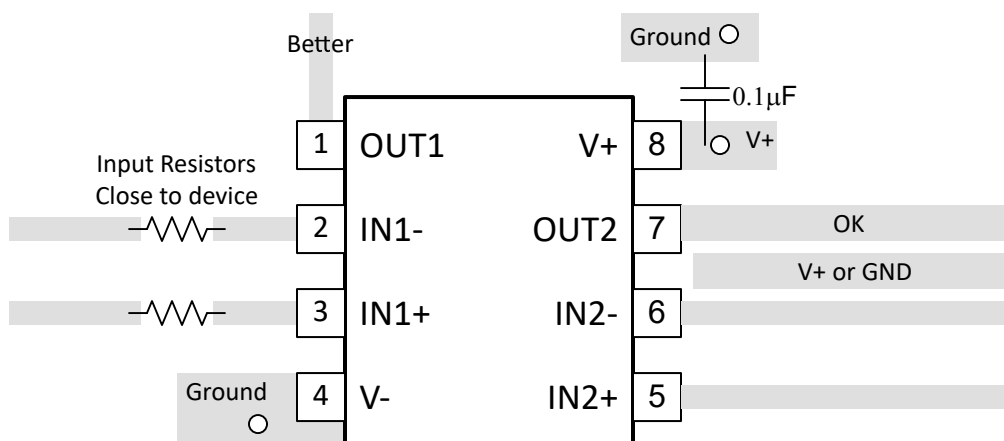


图 9-1. Dual Layout Example

## 10 器件和文档支持

### 10.1 Documentation Support

#### 10.1.1 Related Documentation

*Analog Engineers Circuit Cookbook: Amplifiers (See Comparators section) - SLYY137*

*Precision Design, Comparator with Hysteresis Reference Design— TIDU020*

*Window comparator circuit - SBOA221*

*Reference Design, Window Comparator Reference Design— TIPD178*

*Comparator with and without hysteresis circuit - SBOA219*

*Inverting comparator with hysteresis circuit - SNOA997*

*Non-Inverting Comparator With Hysteresis Circuit - SBOA313*

*A Quad of Independently Func Comparators - SNOA654*

#### 10.2 接收文档更新通知

要接收文档更新通知，请导航至 [ti.com](http://ti.com) 上的器件产品文件夹。点击 *订阅更新* 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

#### 10.3 支持资源

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#### 10.6 术语表

**TI 术语表** 本术语表列出并解释了术语、首字母缩略词和定义。

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins   | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|--------------------------------|---------------|----------------------|------------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TLV1851QDBVRQ1</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 851Q                |
| TLV1851QDBVRQ1.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 851Q                |
| <a href="#">TLV1861QDBVRQ1</a> | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 861Q                |
| TLV1861QDBVRQ1.A               | Active        | Production           | SOT-23 (DBV)   5 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | 861Q                |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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**OTHER QUALIFIED VERSIONS OF TLV1851-Q1, TLV1861-Q1 :**

- Catalog : [TLV1851](#), [TLV1861](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

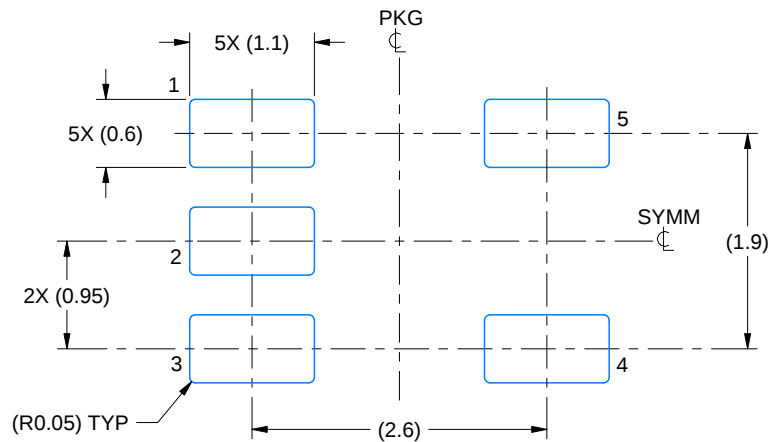


# EXAMPLE BOARD LAYOUT

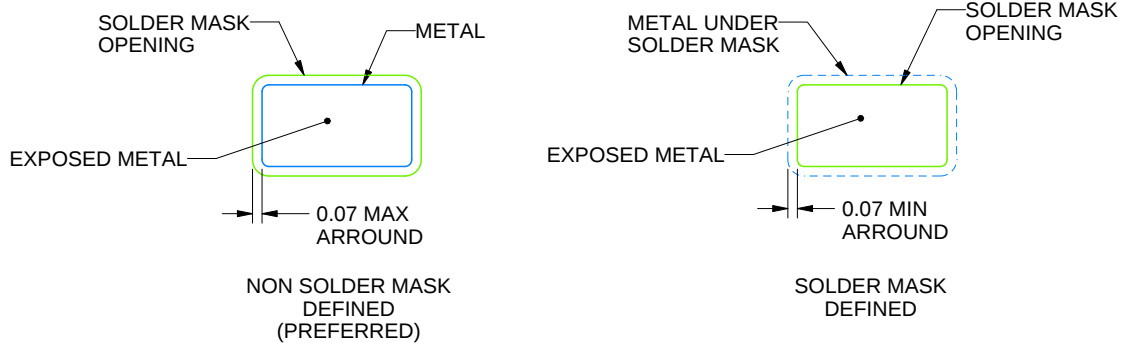
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

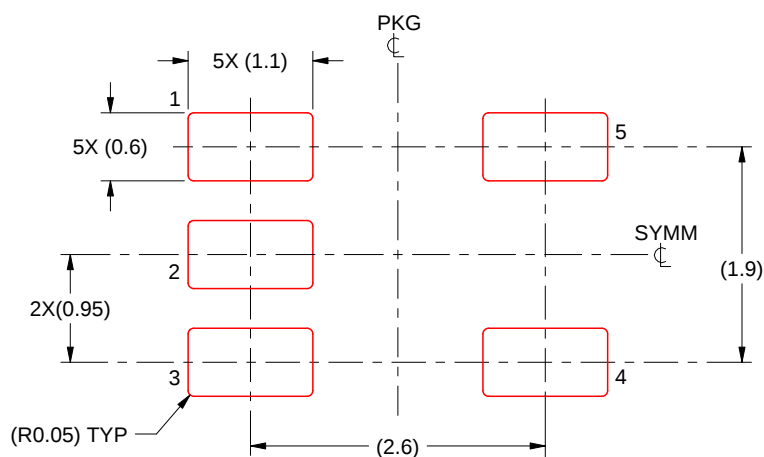
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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